

## **N-Channel 30V MOSFET**

#### **EX3400B**

V <sub>DS</sub> (V)	$R_{DS(on),max}$ (m $\Omega$ )	I <sub>D</sub> (A)
30V	26 @ V <sub>GS</sub> = 10V	5.8

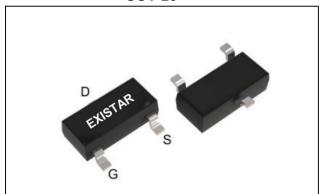
#### **Features**

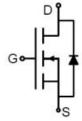
- Low R<sub>DS(on)</sub> trench technology
- Low thermal impedance
- Fast switching speed
- 100% avalanche tested

# **Applications**

- DC/DC conversion
- Load Switch
- Power Management

# SOT-23







## **Package And Ordering Information**

Ordering code	Package	Marking
EX3400B	SOT-23	3400B

## **Ordering Information**

Package	Units/ Reel	Reels/ Inner Box	Units/ Inner Box
SOT-23	3000	15	45000



## **Key Performance Parameters**

Parameter	Value	Unit
VDS, min @ Tj(max)	30	V
ID, pulse	23.2	Α
RDS(ON), max @ VGS=10V	26	mΩ
Qg	20	nC

# Absolute Maximum Ratings at Tj=25°C Unless Otherwise Noted

Parameter		Symbol	Limit	Unit
Drain-source voltage			30	
Gate-source voltage		V <sub>GS</sub>	±12	V
	T <sub>A</sub> =25°C		5.8	
Continuous drain current	T <sub>A</sub> =100°C	- I <sub>D</sub>	3.6	
Pulsed drain current		I <sub>D,pulse</sub>	23.2	А
Avalanche energy, single pulse		E <sub>AS</sub>	20	mJ
Dower discination	T <sub>A</sub> =25°C		1.4	
Power dissipation	T <sub>A</sub> =100°C	$P_{D}$	0.5	W
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 To 150	°C

## **Thermal Characteristics**

Parameter		Symbol	Max.	Uni t
Thermal resistance, junction-to-case	Steady state	R <sub>0</sub> JC	-	
Thermal resistance, junction-to-ambient	Steady state	Reja	90	°C/W

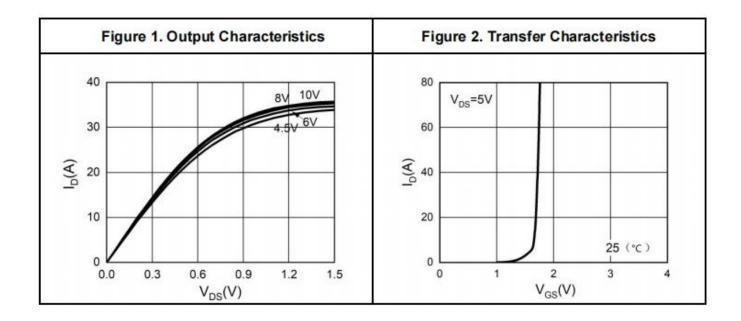
# Electrical Characteristics at Tj=25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions
Static						
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	30			V	V <sub>GS</sub> = 0, I <sub>D</sub> = 250 μA
Gate-source threshold voltage	V <sub>GS</sub> (th)	0.45		1.25	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA
Gate-body leakage	$I_{GSS}$			±100	nA	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±12 V
Zero gate voltage drain current	I <sub>DSS</sub>			1	μA	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V
Drain-source on-resistance	Ros(on)		20	26	mΩ	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A
Drain-source on-resistance	Ros(on)		22	28.5	mΩ	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 2 A
Forward transconductance	gfs		7.8		S	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 2 A

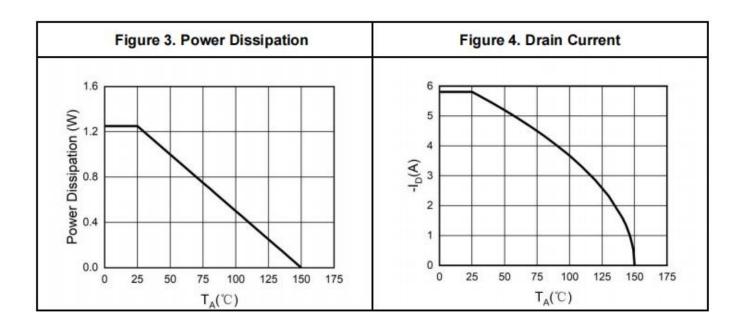


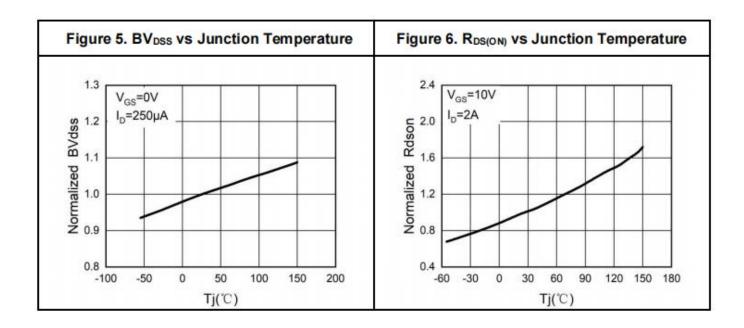
Gate resistance	Rg		1.9		Ω	f=1MHz
	Gate Charge					
Total gate charge	Qg		20			
Gate-source charge	Qgs		2		nC	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 2 A, V <sub>GS</sub> = 4.5 V
Gate-drain charge	Qgd		2.2			
			ynamic	;		
Turn-on delay time	$t_{d(on)}$		5			
Rise time	tr		12			V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V,
Turn-off delay time	$t_{\text{d(off)}}$		24		ns	$R_L = 7.5 \Omega$ , $R_{GEN} = 3 \Omega$
Fall time	$t_f$		2		113	
Input capacitance	C <sub>iss</sub>		696			
Output capacitance	C <sub>oss</sub>		53			V <sub>DS</sub> =15 V, V <sub>GS</sub> = 0 V, f = 1MHz
Reverse transfer capacitance	C <sub>rss</sub>		42		pF	
	Body Diode					
Diode forward voltage	$V_{\text{SD}}$			1.2	V	V <sub>GS</sub> = 0 V, I <sub>F</sub> = 2 A
Reverse recovery time	t <sub>rr</sub>		8.5		ns	1 0 4 1:/-14 400 4/
Reverse recovery charge	Qrr		3.4		nC	I <sub>S</sub> =2 A, di/dt = 100 A/μs

# **Electrical Characteristics Diagrams**

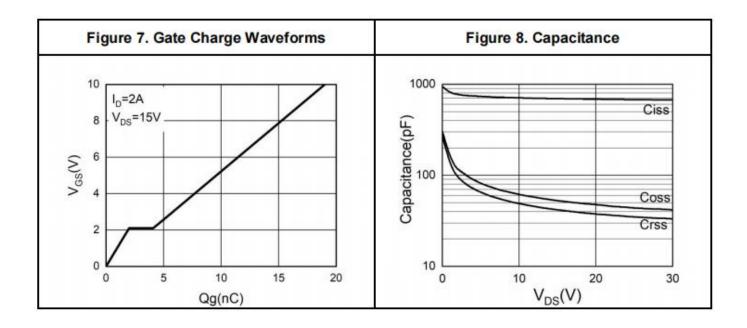


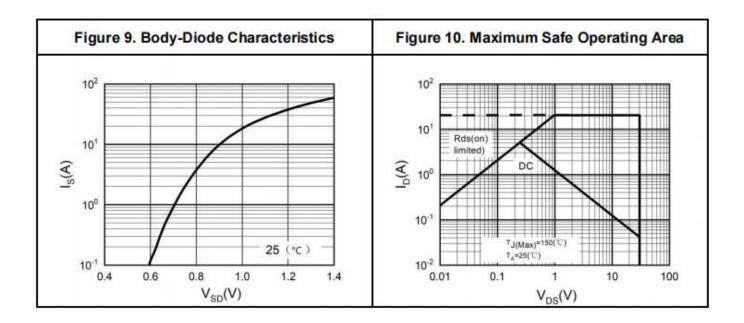






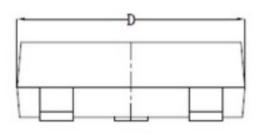


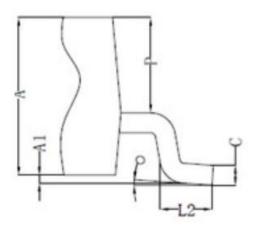


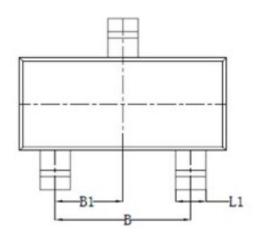


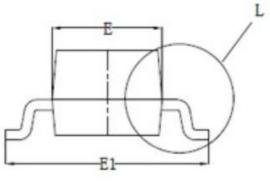


# Package Outline Dimensions









Symbol .	Dim i					
	Min	Nor	Max			
A	0.900	1.000	1.100			
A1	0.000	0, 050	0.100			
L1	0.350	0.400	0, 550			
C	0.100	0.110	0. 120			
D	2. 800	2, 900	3, 000			
Е	1.250	1.300	1.350			
E1	2. 250	2, 400	2, 550			
В	1.800	1.900	2,000			
B1	0.950 TYP					
L2	0.200	0.350	0.450			
P	0.550	0. 575	0.600			



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